



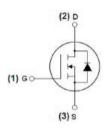
MJ N-Channel Enhancement Mode Power MOSFET

Description

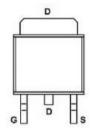
The MJ30H10K uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- ♦ $V_{DS} = 30V, I_D = 100A$ $R_{DS(ON)} < 5.5mΩ$ @ $V_{GS} = 10V$ (Typ:4mΩ)
- ♦ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high EAS
- ◆ Excellent package for good heat dissipation
- ◆ Special process technology for high ESD capability







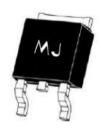
Application

◆ Power switching application

Uninterruptible power supply

Hard switched and high frequency circuits

Marking and pin assignment



TO-252-2L top view

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ30H10K	MJ30H10K	TO-252-2L	2	-	2

Absolute Maximum Ratings (T_A =25 °Cunless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vps	30	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lo	100	А
Drain Current-Continuous(Tc =100°C)	I D(100℃)	70	А
Pulsed Drain Current	Ідм	400	А
Maximum Power Dissipation	Po	110	W
Single pulse avalanche energy (Note 5)	Eas	350	mJ
Operating Junction and Storage Temperature Range	Тл ,Твтв	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	1.36	°C/W





Electrical Characteristics (TA =25℃unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	'		1			
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =250μA	30	-	-	V
Zero Gate Voltage Drain Current	Idss	Vps=30V,Vgs=0V	-	-	1	μA
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	_	-	±100	nA
On Characteristics (Note 3)	-		ı			
Gate Threshold Voltage	VGS(th)	V _{DS} =V _{GS} ,I _D =250µA	1	1.6	3	V
Drain-Source On-State Resistance	Rds(on)	V _{GS} =10V, I _D =20A	_	4.0	5.5	mΩ
Forward Transconductance	grs	V _{DS} =10V,I _D =20A	50	-	-	S
Dynamic Characteristics (Note 4)						
Input Capacitance	Clss		_	3400	-	PF
Output Capacitance	Coss	V _{DS} =25V,V _{GS} =0V F=1.0MHz	-	356	-	PF
Reverse Transfer Capacitance	Crss	-	-	308	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		_	11	-	nS
Turn-on Rise Time	tr	VDD=15V,ID=60A	_	160	-	nS
Turn-Off Delay Time	t _{d(off)}	Vgs=4.5V,Rgen=1.8Ω	_	25	-	nS
Turn-Off Fall Time	tf	-	_	60	-	nS
Total Gate Charge	Qg		_	70	-	nC
Gate-Source Charge	Qgs	V _{DS} =15V,I _D =30A V _{GS} =10V	_	8.8	-	nC
Gate-Drain Charge	Q _{gd}	_	-	16.3	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	Vsp	V _{GS} =0V,I _S =20A	_	-	1.2	V
Diode Forward Current (Note 2)	ls		_	-	100	А
Reverse Recovery Time	trr	T1=25°C 1=-20A	-	56	_	nS
Reverse Recovery Charge	Qrr	TJ=25°C, IF=60A di/dt=100A/µs (Note 3)	-	110		nC
Forward Turn-On Time	ton	Intrinsic turn-on time is ne	aligible(tu	urn-on is d	ominated h	W 6+ L

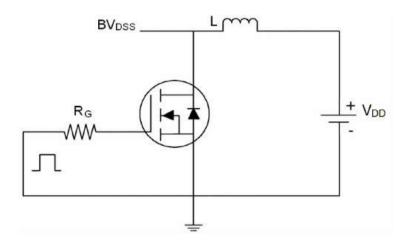
Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4 Guaranteed by design, not subject to production
- $\ensuremath{\mathfrak{T}}$ EAS condition: Tj=25°C,Vpp=15V,Vg=10V,L=0.5mH,Rg=25 Ω

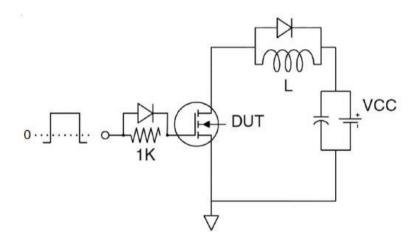




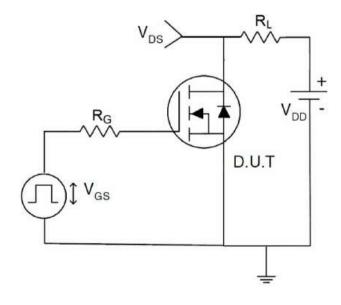
Test circuit



Eas test Circuit



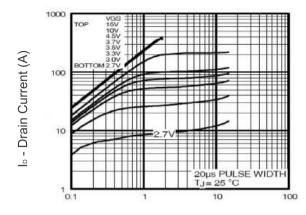
Gate charge test Circuit



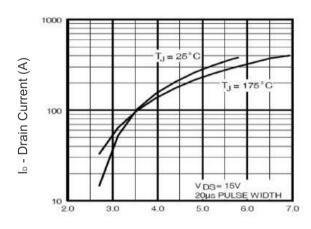
Switch Time Test Circuit



Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V)
Figure 1 Output Characteristics



Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics

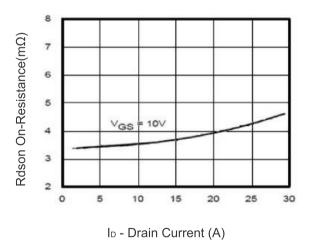
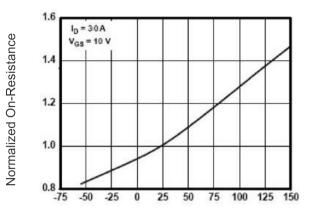
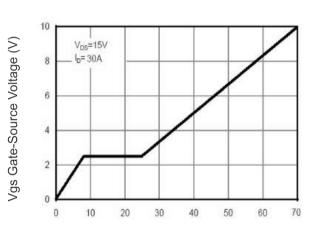


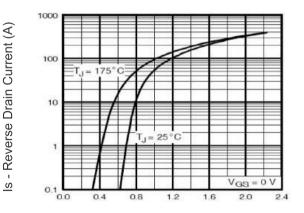
Figure 3 Rdson- Drain Current



TJ -Junction Temperature(°C)
Figure 4 Rdson-Junction Temperature

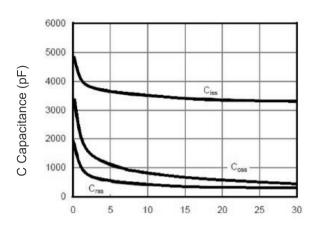


Qg Gate Charge (nC)
Figure 5 Gate Charge

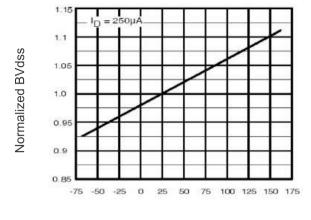


Vsd Source-Drain Voltage (V)
Figure 6 Source- Drain Diode Forward

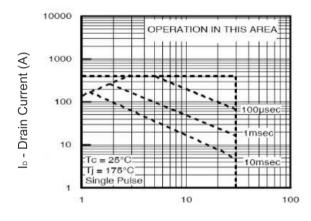




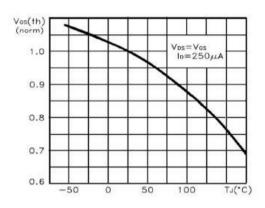
Vds Drain-Source Voltage (V)
Figure 7 Capacitance vs Vds



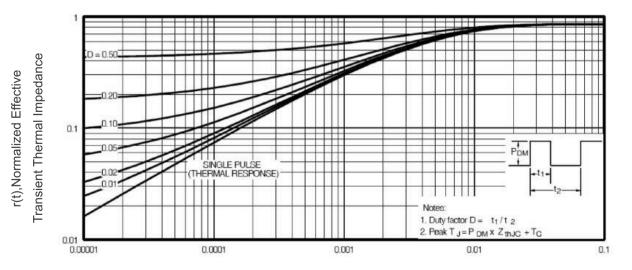
T_J -Junction Temperature(°C)
Figure 9 BVpss vs Junction Temperature



Vds Drain-Source Voltage (V)
Figure 8 Safe Operation Area



T_J -Junction Temperature(°C)
Figure 10 V_{GS(th)} vs Junction Temperature



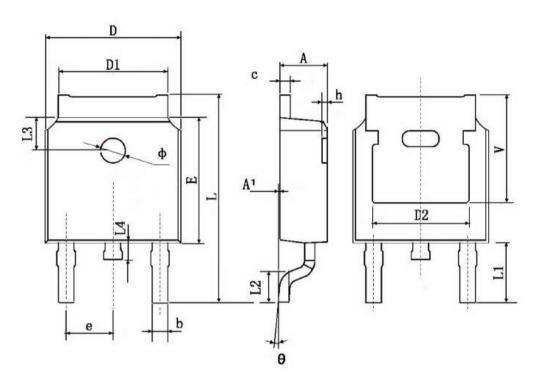
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance



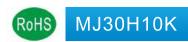


TO-252 Package Information



Symbol	Dimensions	In Millimeters	Dimension	s In Inches	
	Min.	Max.	Min.	Max.	
Α	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.8	30 TYP.	0.190 TYP.		
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067	
L3	1.600	TYP.	0.063	0.063 TYP.	
L4	0.600	1.000	0.024	0.039	
Ф	1.100	1.300	0.043	0.051	
θ	0°	8°	0.	8°	
h	0.000	0.300	0.000	0.012	
V	5.350 TYP.		0.211	TYP.	





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